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TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSII)

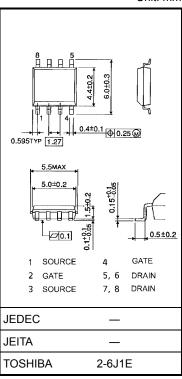
TPC8206

Lithium Ion Battery Applications Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance: R_{DS} (ON) = 40 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 7.0 \text{ S} (typ.)$
- Low leakage current: $IDSS = 10 \mu A (max) (VDS = 60 V)$
- Enhancement-mode: V_{th} = 1.3 to 2.5 V (V_{DS} = 10 V, I_D = 1 mA)

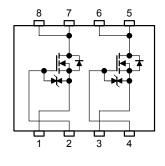
Maximum Ratings (Ta = 25°C)

Char	acteristics	Symbol	Rating	Unit	
Drain-source vol	rain-source voltage		60	V	
Drain-gate voltage	ge (R _{GS} = 20 kΩ)	VDGR	60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	5	А	
	Pulse (Note 1)	I _{DP}	60 60 ±20	~	
Drain power dissipation	Single-device operation (Note 3a)	P _{D (1)}	1.5		
(t = 10 s) (Note 2a)	Single-device value at dual operation (Note 3b)	P _{D (2)}	1.0	W	
Drain power dissipation	Single-device operation (Note 3a)	P _{D (1)}	0.75		
(t = 10 s) (Note 2b)	Single-device value at dual operation (Note 3b)	P _{D (2)}	0.45	W	
Single pulse avalanche energy (Note 4)		E _{AS}	92	mJ	
Avalanche curre	nt	I _{AR}	5	А	
Repetitive avala Single-device va (Note 2a, 3b, 5)	nche energy Ilue at dual operation	E _{AR}	0.1	mJ	
Channel temper	ature	T _{ch}	150	°C	
Storage tempera	ature range	T _{stg}	–55 to 150	°C	



Weight: 0.080 g (typ.)

Circuit Configuration



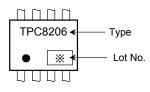
Note: For (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5), please refer to the next page.

This transistor is an electrostatic sensitive device. Please handle with caution.

Thermal Characteristics

Characteristics	Symbol	Max	Unit		
Thermal resistance, channel to embiant	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	83.3	°C/W	
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	Single-device value at dual operation (Note 3b)	R _{th (ch-a) (2)}	125		
Thermal resistance, channel to ambient	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	167		
(t = 10 s) (Note 2b)	Single-device value at dual operation (Note 3b)	R _{th (ch-a) (2)} 278		°C/W	

Marking (Note 6)



Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:

- a) Device mounted on a glass-epoxy board (a)
- b) Device mounted on a glass-epoxy board (b)

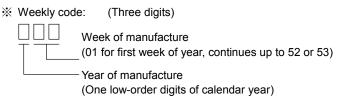




- a) The power dissipation and thermal resistance values are shown for a single device. (During single-device operation, power is only applied to one device.)
- b) The power dissipation and thermal resistance values are shown for a single device. (During dual operation, power is evenly applied to both devices.)

Note 4: $V_{DD} = 25 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}$ (initial), L = 5.0 mH, R_G = 25 Ω , I_{AR} = 5 A

- Note 5: Repetitive rating; pulse width limited by maximum channel temperature
- Note 6: on lower left of the marking indicates Pin 1.



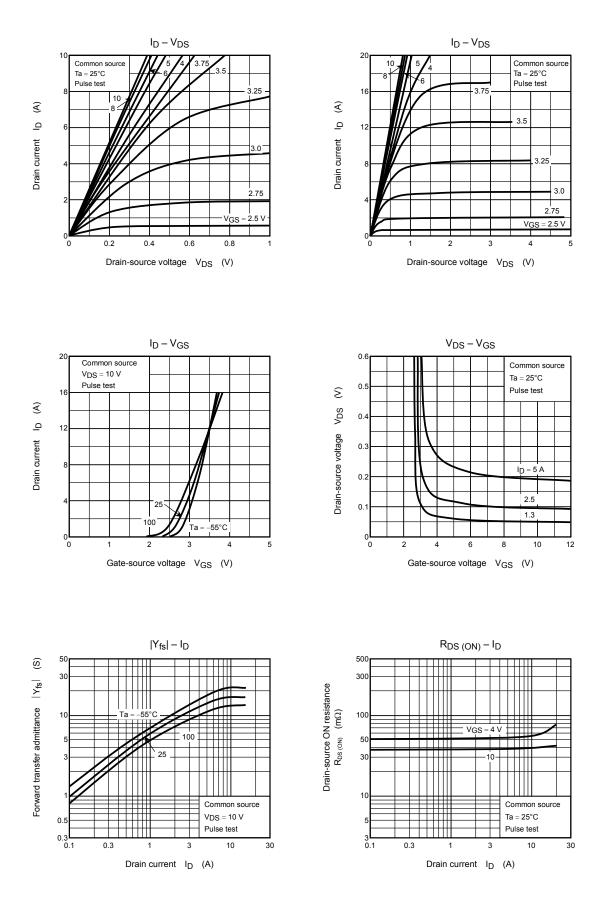
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm 16~V,~V_{DS}=0~V$	_		±10	μA
Drain cut-OFF cu	irrent	I _{DSS}	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_		10	μA
Forward transfer admittance Input capacitance Reverse transfer capacitance Output capacitance Rise time Turn-ON time	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	60			v	
Dialit-Source brea	akuown vollage	V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -12 \text{ V}$	- - ±10 - - 10	v		
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	1.3		2.5	V
Drain-source ON resistance		Deserver	$V_{GS} = 4 V, I_D = 2.5 A$	_	55	75	mΩ
		R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	_	40	50	
Forward transfer admittance		Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	3.5	7.0		S
Input capacitance	e	C _{iss}			800		
Reverse transfer capacitance		C _{rss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz		60		pF
Output capacitance		C _{oss}	-	_	190		
Output capacitanc	Rise time	tr	$V_{GS} \stackrel{10}{}_{0}V \prod_{V} I_{D} = 2.5 \text{ A}$	_	2.6	_	- ns
	Turn-ON time	t _{on}		_	10	_	
	Fall time	t _f		_	2.3	_	
	Turn-OFF time	t _{off}	$V_{DD}\simeq 30~V \label{eq:VDD}$ Duty \leq 1%, t_w = 10 μs	_	22	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	17	_	nC
Gate-source charge		Q _{gs}	$V_{DD} \simeq 48 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	_	12		
Gate-drain ("miller") charge		Q _{gd}	1	_	5	_	

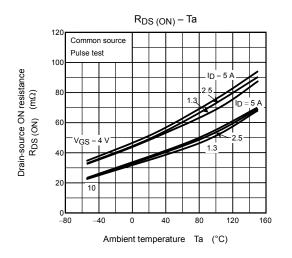
Source-Drain Ratings and Characteristics (Ta = 25°C)

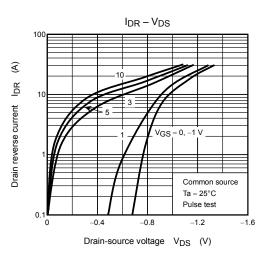
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	—	_	_	20	А
Forward voltage (diode)		V _{DSF}	$I_{DR} = 5$ A, $V_{GS} = 0$ V	_		-1.2	V

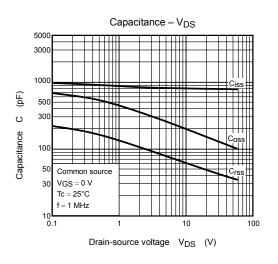
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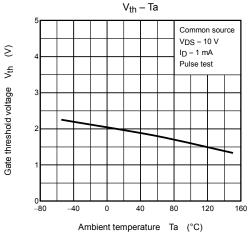


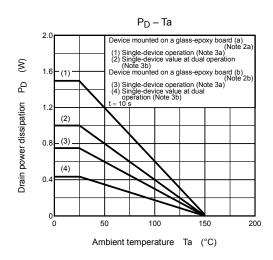
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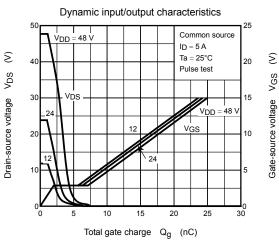








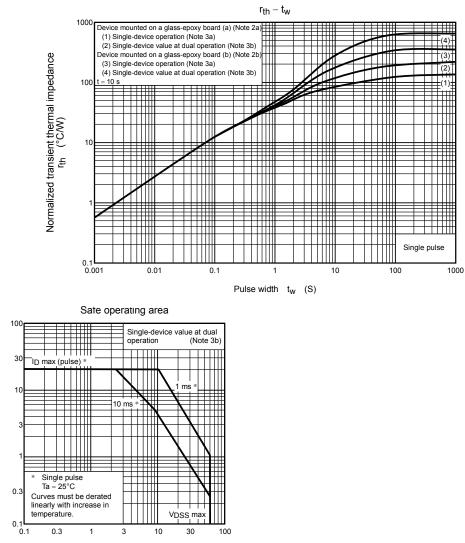




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Drain current



Drain-source voltage V_{DS} (V)

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